ESP32-WROOM-32D & ESP32-WROOM-32U Datasheet

Version 1.4



Espressif Systems

About This Document

This document provides the specifications for the ESP32-WROOM-32D and ESP32-WROOM-32U modules.

Revision History

For revision history of this document, please refer to the last page.

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1. Overview

ESP32-WROOM-32D and ESP32-WROOM-32U are powerful, generic Wi-Fi+BT+BLE MCU modules that target a wide variety of applications, ranging from low-power sensor networks to the most demanding tasks, such as voice encoding, music streaming and MP3 decoding. ESP32-WROOM-32U is different from ESP32-WROOM-32D in that ESP32-WROOM-32U integrates a U.FL connector. For detailed information of the U.FL connector please see Chapter 10.

| Module | ESP32-WROOM-32D | ESP32-WROOM-32U | | |
|---|---------------------------|---|--|--|
| Core | ESP32-D0WD | ESP32-DOWD | | |
| SPI flash | 32 Mbits, 3.3V | 32 Mbits, 3.3V | | |
| Crystal | 40 MHz | 40 MHz | | |
| Antenna | onboard antenna | U.FL connector (which needs to be connected | | |
| Antenna | | to an external IPEX antenna) | | |
| Dimensions (18±0.2) x (25.5±0.2) x (3.1±0.15) (See Figure | | (18±0.1) x (19.2±0.1) x (3.2±0.1) (See Figure 7 | | |
| (Unit: mm) | 6 for details) | for details) | | |
| Schematics | See Figure 3 for details. | See Figure 4 for details. | | |

Table 1: ESP32-WROOM-32D vs. ESP32-WROOM-32U

At the core of the two modules are the ESP32-D0WD chip*. The chip embedded is designed to be scalable and adaptive. There are two CPU cores that can be individually controlled, and the CPU clock frequency is adjustable from 80 MHz to 240 MHz. The user may also power off the CPU and make use of the low-power co-processor to constantly monitor the peripherals for changes or crossing of thresholds. ESP32 integrates a rich set of peripherals, ranging from capacitive touch sensors, Hall sensors, SD card interface, Ethernet, high-speed SPI, UART, I2S and I2C.

Note:

* For details on the part number of the ESP32 series, please refer to the document <u>ESP32 Datasheet</u>.

The integration of Bluetooth, Bluetooth LE and Wi-Fi ensures that a wide range of applications can be targeted, and that the module is future proof: using Wi-Fi allows a large physical range and direct connection to the internet through a Wi-Fi router, while using Bluetooth allows the user to conveniently connect to the phone or broadcast low energy beacons for its detection. The sleep current of the ESP32 chip is less than 5 μ A, making it suitable for battery powered and wearable electronics applications. ESP32 supports a data rate of up to 150 Mbps, and 20.5 dBm output power at the antenna to ensure the widest physical range. As such the chip does offer industry-leading specifications and the best performance for electronic integration, range, power consumption, and connectivity.

The operating system chosen for ESP32 is freeRTOS with LwIP; TLS 1.2 with hardware acceleration is built in as well. Secure (encrypted) over the air (OTA) upgrade is also supported, so that developers can continually upgrade their products even after their release.

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Table 2 provides the specifications of ESP32-WROOM-32D and ESP32-WROOM-32U.

| Categories | Items | Specifications |
|---------------|--|---|
| | RF Certification | FCC/CE (RED)/IC/TELEC/KCC/SRRC/NCC |
| Certification | Wi-Fi Certification | Wi-Fi Alliance |
| | Bluetooth certification | BQB |
| | Green Certification | REACH/RoHS |
| | | 802.11 b/g/n (802.11n up to 150 Mbps) |
| | Protocols | A-MPDU and A-MSDU aggregation and 0.4 μ s guard |
| Wi-Fi | | interval support |
| | Frequency range | 2.4 ~ 2.5 GHz |
| | Protocols | Bluetooth v4.2 BR/EDR and BLE specification |
| | | NZIF receiver with –97 dBm sensitivity |
| Bluetooth | Radio | Class-1, class-2 and class-3 transmitter |
| | | AFH |
| | Audio | CVSD and SBC |
| | | SD card, UART, SPI, SDIO, I2C, LED PWM, Motor |
| | Module interface | PWM, I2S, IR |
| | | GPIO, capacitive touch sensor, ADC, DAC |
| | On-chip sensor | Hall sensor |
| | On-board clock | 40 MHz crystal |
| | Operating voltage/Power supply | 2.7 ~ 3.6V |
| Hardware | Operating current | Average: 80 mA |
| | Minimum current delivered by power supply | 500 mA |
| | Recommended operating tem- perature range | -40°C ∼ +85°C |
| | Wi-Fi mode | Station/SoftAP/SoftAP+Station/P2P |
| | Wi-Fi Security | WPA/WPA2/WPA2-Enterprise/WPS |
| | Encryption | AES/RSA/ECC/SHA |
| | Eirmwara ungrada | UART Download / OTA (download and write firmware |
| Software | Firmware upgrade | via network or host) |
| | Software development | Supports Cloud Server Development / SDK for cus- |
| | | tom firmware development |
| | Network protocols | IPv4, IPv6, SSL, TCP/UDP/HTTP/FTP/MQTT |
| | User configuration | AT instruction set, cloud server, Android/iOS app |

Table 2: ESP32-WROOM-32D and ESP32-WROOM-32U Specifications

2. Pin Definitions

2.1 Pin Layout

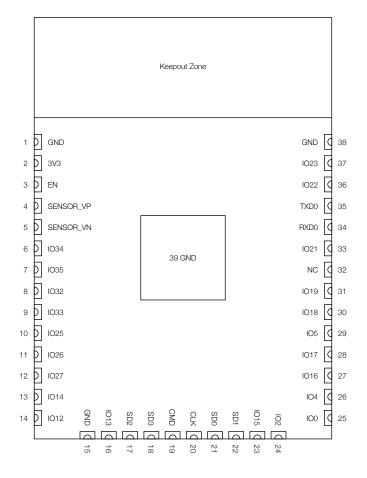


Figure 1: ESP32-WROOM-32D Pin layout

Note:

The pin layout of ESP32-WROOM-32U is the same as that of ESP32-WROOM-32D, except that ESP32-WROOM-32U has no keepout zone.

2.2 Pin Description

The ESP32-WROOM-32D and ESP32-WROOM-32U have 38 pins. See pin definitions in Table 3.

Table 3: Pin Definitions

| Name | No. | Туре | Function |
|-----------|-----|------|------------------------------------|
| GND | 1 | Р | Ground |
| 3V3 | 2 | Р | Power supply |
| EN | 3 | I | Module-enable signal. Active high. |
| SENSOR_VP | 4 | I | GPIO36, ADC1_CH0, RTC_GPIO0 |
| SENSOR_VN | 5 | I | GPIO39, ADC1_CH3, RTC_GPIO3 |
| IO34 | 6 | I | GPIO34, ADC1_CH6, RTC_GPIO4 |
| IO35 | 7 | I | GPIO35, ADC1_CH7, RTC_GPIO5 |

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| Name | No. | Туре | Function |
|-----------|-----|------|---|
| IO32 | 8 | I/O | GPIO32, XTAL_32K_P (32.768 kHz crystal oscillator input), ADC1_CH4, TOUCH9, RTC_GPIO9 |
| | | | GPIO33, XTAL_32K_N (32.768 kHz crystal oscillator output), ADC1_CH5, |
| 033 9 1/0 | | I/O | TOUCH8, RTC_GPI08 |
| IO25 | 10 | I/O | GPIO25, DAC_1, ADC2_CH8, RTC_GPIO6, EMAC_RXD0 |
| IO26 | 11 | I/O | GPIO26, DAC_2, ADC2_CH9, RTC_GPIO7, EMAC_RXD1 |
| IO27 | 12 | I/O | GPIO27, ADC2_CH7, TOUCH7, RTC_GPIO17, EMAC_RX_DV |
| IO14 | 13 | I/O | GPIO14, ADC2_CH6, TOUCH6, RTC_GPIO16, MTMS, HSPICLK, HS2_CLK, SD_CLK, EMAC_TXD2 |
| IO12 | 14 | I/O | GPIO12, ADC2_CH5, TOUCH5, RTC_GPIO15, MTDI, HSPIQ, HS2_DATA2, SD_DATA2, EMAC_TXD3 |
| GND | 15 | P | Ground |
| | | | GPI013, ADC2_CH4, TOUCH4, RTC_GPI014, MTCK, HSPID, |
| IO13 | 16 | I/O | HS2_DATA3, SD_DATA3, EMAC_RX_ER |
| SHD/SD2* | 17 | I/O | GPIO9, SD DATA2, SPIHD, HS1 DATA2, U1RXD |
| SWP/SD3* | 18 | I/O | GPIO10, SD DATA3, SPIWP, HS1 DATA3, U1TXD |
| SCS/CMD* | 19 | I/O | GPI011, SD_CMD, SPICS0, HS1_CMD, U1RTS |
| SCK/CLK* | 20 | I/O | GPIO6, SD_CLK, SPICLK, HS1_CLK, U1CTS |
| SDO/SD0* | 21 | I/O | GPIO7, SD_DATA0, SPIQ, HS1_DATA0, U2RTS |
| SDI/SD1* | 22 | I/O | GPIO8, SD_DATA1, SPID, HS1_DATA1, U2CTS |
| IO15 | 23 | I/O | GPIO15, ADC2_CH3, TOUCH3, MTDO, HSPICSO, RTC_GPIO13, HS2_CMD, SD_CMD, EMAC_RXD3 |
| 102 | 24 | I/O | GPIO2, ADC2_CH2, TOUCH2, RTC_GPIO12, HSPIWP, HS2_DATA0, SD DATA0 |
| | | | GPIO0, ADC2_CH1, TOUCH1, RTC_GPIO11, CLK_OUT1, |
| 100 | 25 | I/O | EMAC_TX_CLK |
| | | | GPIO4, ADC2_CH0, TOUCH0, RTC_GPIO10, HSPIHD, HS2_DATA1, |
| IO4 | 26 | I/O | SD_DATA1, EMAC_TX_ER |
| IO16 | 27 | I/O | GPIO16, HS1_DATA4, U2RXD, EMAC_CLK_OUT |
| IO17 | 28 | I/O | GPIO17, HS1_DATA5, U2TXD, EMAC_CLK_OUT_180 |
| IO5 | 29 | I/O | GPIO5, VSPICS0, HS1_DATA6, EMAC_RX_CLK |
| IO18 | 30 | I/O | GPIO18, VSPICLK, HS1_DATA7 |
| IO19 | 31 | I/O | GPIO19, VSPIQ, UOCTS, EMAC_TXD0 |
| NC | 32 | - | - |
| IO21 | 33 | I/O | GPIO21, VSPIHD, EMAC_TX_EN |
| RXD0 | 34 | I/O | GPIO3, U0RXD, CLK_OUT2 |
| TXD0 | 35 | I/O | GPIO1, U0TXD, CLK_OUT3, EMAC_RXD2 |
| IO22 | 36 | I/O | GPIO22, VSPIWP, UORTS, EMAC_TXD1 |
| IO23 | 37 | I/O | GPIO23, VSPID, HS1_STROBE |
| GND | 38 | P | Ground |

Important:

* Pins SCK/CLK, SDO/SD0, SDI/SD1, SHD/SD2, SWP/SD3 and SCS/CMD, namely, GPIO6 to GPIO11 are connected to the integrated SPI flash integrated on the module and are not recommended for other uses.

2.3 Strapping Pins

ESP32 has five strapping pins, which can be seen in Chapter 6 Schematics:

- MTDI
- GPIO0
- GPIO2
- MTDO
- GPI05

Software can read the values of these five bits from register "GPIO_STRAPPING".

During the chip's system reset (power-on-reset, RTC watchdog reset and brownout reset), the latches of the strapping pins sample the voltage level as strapping bits of "0" or "1", and hold these bits until the chip is powered down or shut down. The strapping bits configure the device's boot mode, the operating voltage of VDD_SDIO and other initial system settings.

Each strapping pin is connected to its internal pull-up/pull-down during the chip reset. Consequently, if a strapping pin is unconnected or the connected external circuit is high-impedance, the internal weak pull-up/pull-down will determine the default input level of the strapping pins.

To change the strapping bit values, users can apply the external pull-down/pull-up resistances, or use the host MCU's GPIOs to control the voltage level of these pins when powering on ESP32.

After reset, the strapping pins work as normal-function pins.

Refer to Table 4 for a detailed boot-mode configuration by strapping pins.

| Voltage of Internal LDO (VDD_SDIO) | | | | | | | | |
|---|-----------|------------------------|-------------------------|----------------------|---------|--|--|--|
| Pin | Default | 3.5 | 3V | 1.8V | | | | |
| MTDI | Pull-down | (|) | - | 1 | | | |
| | | | Booting Mode | | | | | |
| Pin | Default | SPI | Boot | Downlo | ad Boot | | | |
| GPIO0 | Pull-up | - | 1 | (|) | | | |
| GPIO2 | Pull-down | Don't | -care | (|) | | | |
| | E | Enabling/Disabling Deb | ugging Log Print over l | JOTXD During Booting | | | | |
| Pin | Default | U0TXD ⁻ | Toggling | U0TXD Silent | | | | |
| MTDO | Pull-up | - | l | 0 | | | | |
| | | | Timing of SDIO Slave | | | | | |
| Falling-edge Input | | Falling-edge Input | Rising-edge Input | Rising-edge Input | | | | |
| Pin Default Falling-edge Output Rising-edge | | Rising-edge Output | Falling-edge Output | Rising-edge Output | | | | |
| MTDO | Pull-up | 0 0 | | 1 | 1 | | | |
| GPIO5 | Pull-up | 0 | 1 | 0 | 1 | | | |

Table 4: Strapping Pins

Note:

• Firmware can configure register bits to change the settings of "Voltage of Internal LDO (VDD_SDIO)" and "Timing of SDIO Slave" after booting.

• Both ESP32-WROOM-32D and ESP32-WROOM-32U integrate a 3.3V SPI flash, so the pin MTDI cannot be set to 1 when the modules are powered up.

3. Functional Description

This chapter describes the modules and functions integrated in ESP32-WROOM-32D and ESP32-WROOM-32U.

3.1 CPU and Internal Memory

ESP32-D0WD contains a dual-core Xtensa[®] 32-bit LX6 MCU. The internal memory includes:

- 448 kB of ROM for booting and core functions.
- 520 kB of on-chip SRAM for data and instructions.
- 8 kB of SRAM in RTC, which is called RTC FAST Memory and can be used for data storage; it is accessed by the main CPU during RTC Boot from the Deep-sleep mode.
- 8 kB of SRAM in RTC, which is called RTC SLOW Memory and can be accessed by the co-processor during the Deep-sleep mode.
- 1 kbit of eFuse: 256 bits are used for the system (MAC address and chip configuration) and the remaining 768 bits are reserved for customer applications, including flash-encryption and chip-ID.

3.2 External Flash and SRAM

ESP32 supports multiple external QSPI flash and SRAM chips. More details can be found in Chapter SPI in the *ESP32 Technical Reference Manual*. ESP32 also supports hardware encryption/decryption based on AES to protect developers' programs and data in flash.

ESP32 can access the external QSPI flash and SRAM through high-speed caches.

- Up to 16 MB of external flash can be mapped into CPU instruction memory space and read-only memory space simultaneously.
 - When external flash is mapped into CPU instruction memory space, up to 11 MB+248 KB can be mapped at a time. Note that if more than 3 MB+248 KB are mapped, cache performance will be reduced due to speculative reads by the CPU.
 - When external flash is mapped into read-only data memory space, up to 4 MB can be mapped at a time. 8-bit, 16-bit and 32-bit reads are supported.
- External SRAM can be mapped into CPU data memory space. SRAM up to 8 MB is supported and up to 4 MB can be mapped at a time. 8-bit, 16-bit and 32-bit reads and writes are supported.

Both ESP32-WROOM-32D and ESP32-WROOM-32U integrate a 4 MB of external SPI flash. The 4-MB SPI flash can be memory-mapped onto the CPU code space, supporting 8, 16 and 32-bit access. Code execution is supported. The integrated SPI flash is connected to GPIO6, GPIO7, GPIO8, GPIO9, GPIO10 and GPIO11. These six pins cannot be used as regular GPIOs.

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3.3 Crystal Oscillators

The module uses a 40-MHz crystal oscillator.

3.4 RTC and Low-Power Management

With the use of advanced power-management technologies, ESP32 can switch between different power modes.

- Power modes
 - Active mode: The chip radio is powered on. The chip can receive, transmit, or listen.
 - Modem-sleep mode: The CPU is operational and the clock is configurable. The Wi-Fi/Bluetooth baseband and radio are disabled.
 - Light-sleep mode: The CPU is paused. The RTC memory and RTC peripherals, as well as the ULP co-processor are running. Any wake-up events (MAC, host, RTC timer, or external interrupts) will wake up the chip.
 - Deep-sleep mode: Only RTC memory and RTC peripherals are powered on. Wi-Fi and Bluetooth connection data are stored in the RTC memory. The ULP co-processor is functional.
 - Hibernation mode: The internal 8-MHz oscillator and ULP co-processor are disabled. The RTC recovery
 memory is powered down. Only one RTC timer on the slow clock and certain RTC GPIOs are active.
 The RTC timer or the RTC GPIOs can wake up the chip from the Hibernation mode.

The power consumption varies with different power modes and work statuses of functional modules. Please see Table 5 for details.

| Power mode | Description | Power consumption | |
|---------------------|--|-----------------------------------|--|
| | Wi-Fi Tx packet | | |
| Active (RF working) | Wi-Fi / BT Tx packet | Please refer to ESP32 Datasheet. | |
| | Wi-Fi / BT Rx and listening | | |
| | | Max speed 240 MHz: 30 mA ~ 50 mA | |
| Modem-sleep | The CPU is powered on. | Normal speed 80 MHz: 20 mA ~ 25 m | |
| | | Slow speed 2 MHz: 2 mA ~ 4 mA | |
| Light-sleep | - | 0.8 mA | |
| | The ULP co-processor is powered on. | 150 μA | |
| Deep-sleep | ULP sensor-monitored pattern | 100 μA @1% duty | |
| | RTC timer + RTC memory | 10 µA | |
| Hibernation | RTC timer only | 5 µA | |
| Power off | CHIP_PU is set to low level, the chip is powered off | 0.1 μΑ | |

Table 5: Power Consumption by Power Modes

Note:

- When Wi-Fi is enabled, the chip switches between Active and Modem-sleep mode. Therefore, power consumption changes accordingly.
- In Modem-sleep mode, the CPU frequency changes automatically. The frequency depends on the CPU load and the peripherals used.
- During Deep-sleep, when the ULP co-processor is powered on, peripherals such as GPIO and I2C are able to operate.
- When the system works in the ULP sensor-monitored pattern, the ULP co-processor works with the ULP sensor periodically; ADC works with a duty cycle of 1%, so the power consumption is 100 μ A.

4. Peripherals and Sensors

Please refer to Section Peripherals and Sensors in <u>ESP32 Datasheet</u>.

Note:

External connections can be made to any GPIO except for GPIOs in the range 6-11. These six GPIOs are connected to the module's integrated SPI flash. For details, please see Section 6 Schematics.

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Stresses beyond the absolute maximum ratings listed in the table below may cause permanent damage to the device. These are stress ratings only, and do not refer to the functional operation of the device.

Table 6: Absolute Maximum Ratings

| Symbol | Parameter | Min | Max | Unit |
|--------------------|---------------------|------|-----|------|
| VDD33 | - | -0.3 | 3.6 | V |
| T _{store} | Storage temperature | -40 | 150 | °C |

5.2 Recommended Operating Conditions

Symbol Unit Parameter Min Typical Max VDD33 2.7 3.3 3.6 V _ Current delivered by external power supply 0.5 А IVDD _ -Т Operating temperature -4085 °C -

Table 7: Recommended Operating Conditions

5.3 DC Characteristics (3.3V, 25°C)

Symbol Parameter Min Unit Тур Max _ 2 _ C_{IN} Pin capacitance pF High-level input voltage $0.75 \times VDD^1$ VDD + 0.3 V V_{IH} _ V_{IL} Low-level input voltage -0.3 _ 0.25 × VDD V High-level input current 50 nA $|_{IH}$ _ _ 50 nA Low-level input current _ $|_{IL}$ _ V V_{OH} $0.8 \times VDD$ High-level output voltage _ $0.1 \times VDD$ V V_{OL} Low-level output voltage _ _ High-level source current (VDD = 3.3V, V_{OH} = 40 mΑ $|_{OH}$ 2.64V, PAD DRIVER = 3) Low-level sink current (VDD = 3.3V, V_{OL} = 28 mΑ $|_{OL}$ 0.495V, PAD_DRIVER = 3) R_{PU} Pull-up resistor _ 45 _ kΩ Pull-down resistor 45 _ kΩ R_{PD} _ Low-level input voltage of EN to reset the mod-V 0.6 V_{IL_nRST} ule

Table 8: DC Characteristics

1. VDD is the I/O voltage for a particular power domain of pins. More details can be found in Appendix IO_MUX of ESP32 Datasheet.

5.4 Wi-Fi Radio

| Description | Min | Typical | Max | Unit |
|----------------------------------|-----------------|-----------|------|------|
| Input frequency | 2412 | - | 2484 | MHz |
| Output impedance* | - | * | - | Ω |
| | Tx power | | | |
| Output power of PA for 72.2 Mbps | 13 | 14 | 15 | dBm |
| Output power of PA for 11b mode | 19.5 | 20 | 20.5 | dBm |
| | Sensitivity | , | | |
| DSSS, 1 Mbps | - | -98 | - | dBm |
| CCK, 11 Mbps | - | -91 | - | dBm |
| OFDM, 6 Mbps | - | -93 | - | dBm |
| OFDM, 54 Mbps | - | -75 | - | dBm |
| HT20, MCS0 | - | -93 | - | dBm |
| HT20, MCS7 | - | -73 | - | dBm |
| HT40, MCS0 | - | -90 | - | dBm |
| HT40, MCS7 | - | -70 | - | dBm |
| MCS32 | - | -89 | - | dBm |
| A | djacent channel | rejection | | |
| OFDM, 6 Mbps | - | 37 | - | dB |
| OFDM, 54 Mbps | - | 21 | - | dB |
| HT20, MCS0 | - | 37 | - | dB |
| HT20, MCS7 | - | 20 | - | dB |

Table 9: Wi-Fi Radio Characteristics

*For the modules that use IPEX antennas, the output impedance is 50Ω . For other modules without IPEX antennas, users do not need to concern about the output impedance.

5.5 BLE Radio

5.5.1 Receiver

Table 10: Receiver Characteristics – BLE

| Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------------------|----------------|-----|-----|-----|------|
| Sensitivity @30.8% PER | - | - | -97 | - | dBm |
| Maximum received signal @30.8% PER | - | 0 | - | - | dBm |
| Co-channel C/I | - | - | +10 | - | dB |
| | F = F0 + 1 MHz | - | -5 | - | dB |
| | F = F0 – 1 MHz | - | -5 | - | dB |
| Adiagant abannal adjactivity C/L | F = F0 + 2 MHz | - | -25 | - | dB |
| Adjacent channel selectivity C/I | F = FO - 2 MHz | - | -35 | - | dB |
| | F = FO + 3 MHz | - | -25 | - | dB |
| | F = F0 – 3 MHz | - | -45 | - | dB |

| Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------------------|---------------------|-----|-----|-----|------|
| | 30 MHz ~ 2000 MHz | -10 | - | - | dBm |
| Out of band blocking porformance | 2000 MHz ~ 2400 MHz | -27 | - | - | dBm |
| Out-of-band blocking performance | 2500 MHz ~ 3000 MHz | -27 | - | - | dBm |
| | 3000 MHz ~ 12.5 GHz | -10 | - | - | dBm |
| Intermodulation | - | -36 | - | - | dBm |

5.5.2 Transmitter

| Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------------------------|----------------------|-----|-------|-----|-----------|
| RF transmit power | - | - | 0 | - | dBm |
| Gain control step | - | - | 3 | - | dBm |
| RF power control range | - | -12 | - | +12 | dBm |
| Adjacent channel transmit power | $F = F0 \pm 2 MHz$ | - | -52 | - | dBm |
| | $F = F0 \pm 3 MHz$ | - | -58 | - | dBm |
| | $F = F0 \pm > 3 MHz$ | - | -60 | - | dBm |
| $\Delta f 1_{\text{avg}}$ | - | - | - | 265 | kHz |
| $\Delta f_{2\max}$ | - | 247 | - | - | kHz |
| $\Delta f 2_{avg} / \Delta f 1_{avg}$ | - | - | -0.92 | - | - |
| ICFT | - | - | -10 | - | kHz |
| Drift rate | - | - | 0.7 | - | kHz/50 μs |
| Drift | - | - | 2 | - | kHz |

Table 11: Transmitter Characteristics – BLE

5.6 Reflow Profile

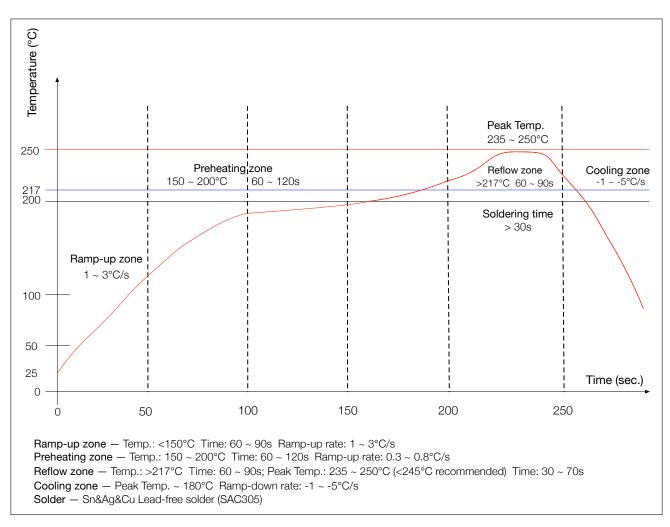


Figure 2: Reflow Profile

6. Schematics

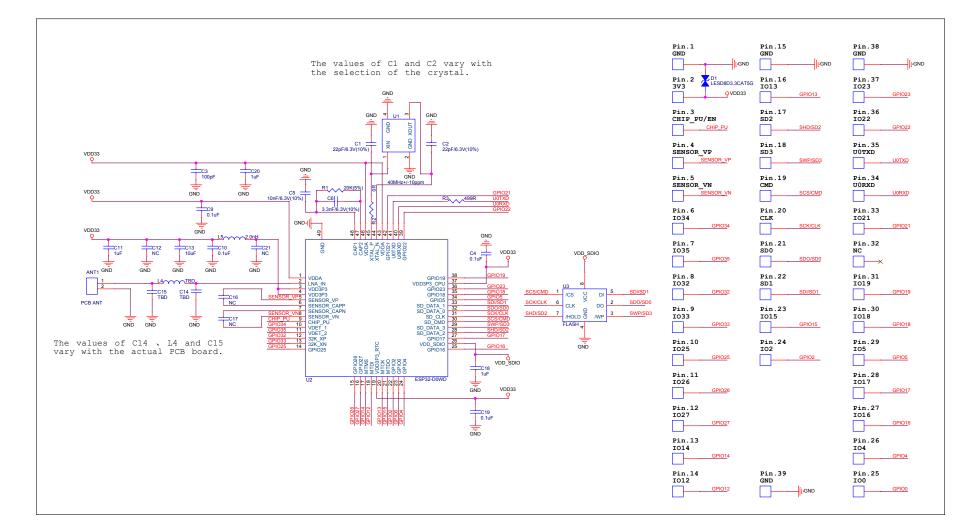
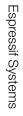


Figure 3: ESP32-WROOM-32D Schematics

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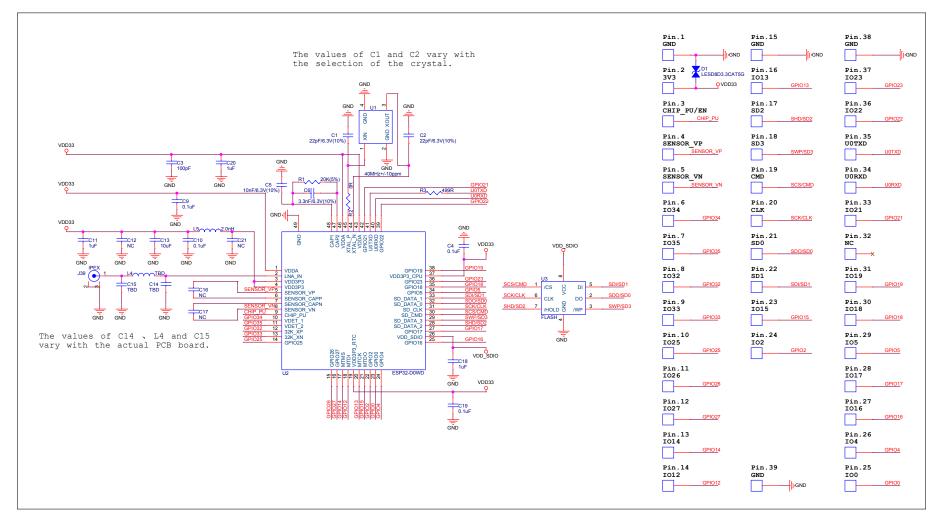
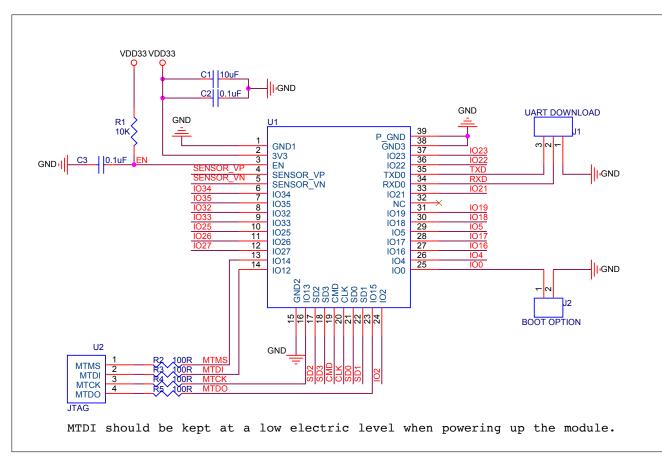


Figure 4: ESP32-WROOM-32U Schematics

7. Peripheral Schematics



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PERIPHERAL SCHEMATICS

Figure 5: ESP32-WROOM-32D & ESP32-WROOM-32U Peripheral Schematics

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Note:

Soldering Pad 39 to the Ground is not necessary for a satisfactory thermal performance. If users do want to solder it, they need to ensure that the correct quantity of soldering paste is applied.

- When ESP32 is powered on and off repeatedly by switching the power rails, and there is a large capacitor on the 3V3 rail, a discharge circuit can be added to the 3V3 rail. Please find details in Chapter **Peripheral Schematics**, in <u>ESP32-WROOM-32 Datasheet</u>.
- When battery is used as the power supply for ESP32 series of chips and modules, a supply voltage supervisor is recommended to avoid boot failure due to low voltage. Users are recommended to pull CHIP_PU low if the power supply for ESP32 is below 2.3V. For the reset circuit, please refer to Chapter **Peripheral Schematics**, in <u>ESP32-WROOM-32 Datasheet</u>.

8. Physical Dimensions

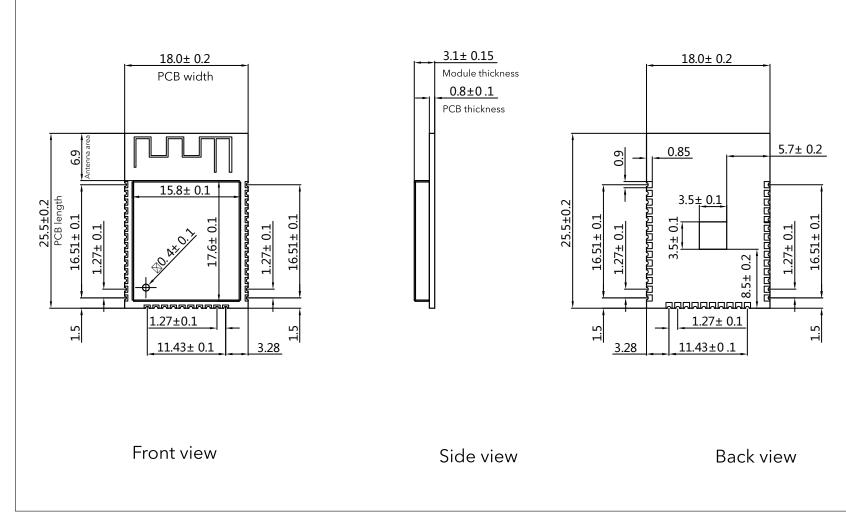
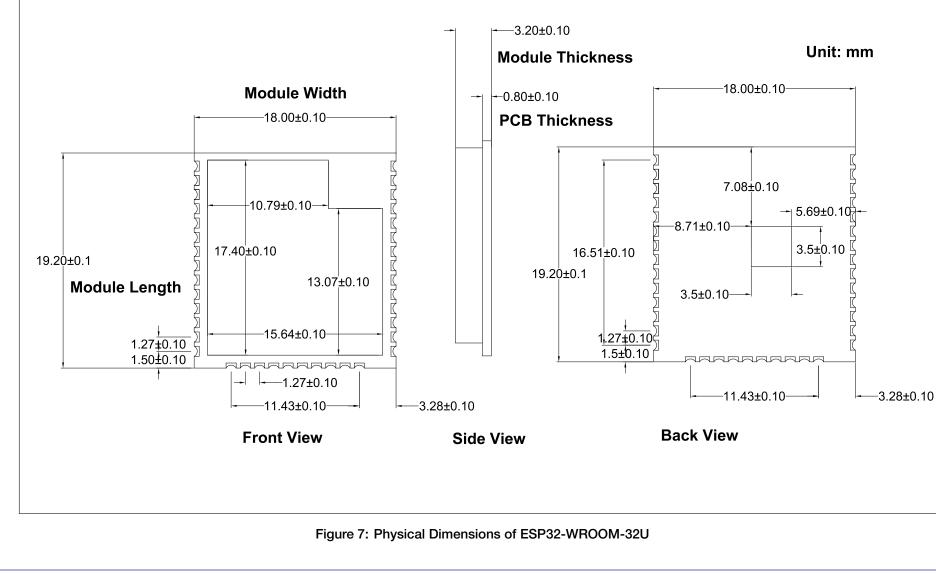


Figure 6: Physical Dimensions of ESP32-WROOM-32D

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Note:

All dimensions are in millimeters.



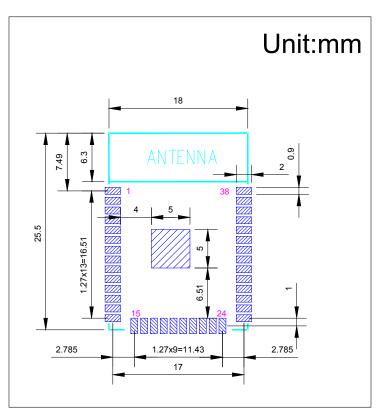


Figure 8: Recommended PCB Land Pattern of ESP32-WROOM-32D

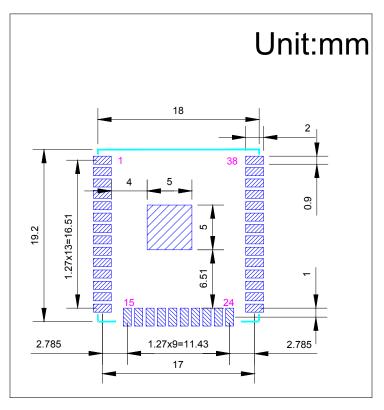


Figure 9: Recommended PCB Land Pattern of ESP32-WROOM-32U

10. U.FL Connector Dimensions

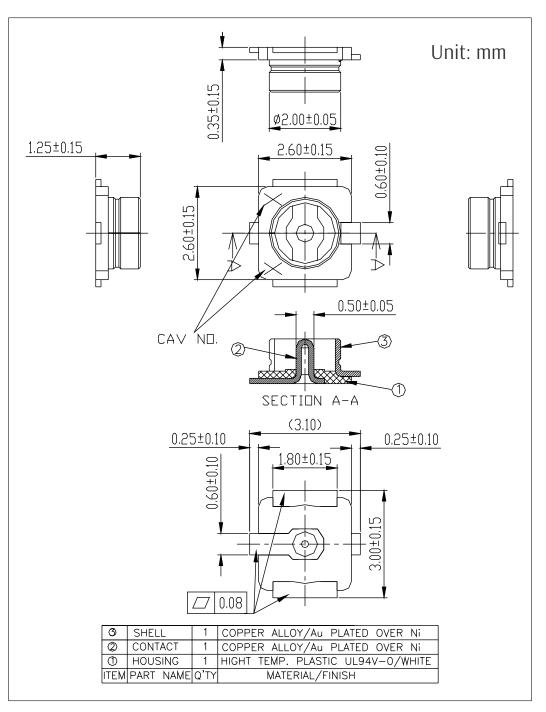


Figure 10: ESP32-WROOM-32U U.FL Dimensions

11. Learning Resources

11.1 Must-Read Documents

The following link provides documents related to ESP32.

ESP32 Datasheet

This document provides an introduction to the specifications of the ESP32 hardware, including overview, pin definitions, functional description, peripheral interface, electrical characteristics, etc.

- <u>ESP-IDF Programming Guide</u> It hosts extensive documentation for ESP-IDF ranging from hardware guides to API reference.
- <u>ESP32 Technical Reference Manual</u> The manual provides detailed information on how to use the ESP32 memory and peripherals.
- ESP32 Hardware Resources

The zip files include the schematics, PCB layout, Gerber and BOM list of ESP32 modules and development boards.

• ESP32 Hardware Design Guidelines

The guidelines outline recommended design practices when developing standalone or add-on systems based on the ESP32 series of products, including the ESP32 chip, the ESP32 modules and development boards.

• ESP32 AT Instruction Set and Examples

This document introduces the ESP32 AT commands, explains how to use them, and provides examples of several common AT commands.

• Espressif Products Ordering Information

11.2 Must-Have Resources

Here are the ESP32-related must-have resources.

• ESP32 BBS

This is an Engineer-to-Engineer (E2E) Community for ESP32 where you can post questions, share knowledge, explore ideas, and help solve problems with fellow engineers.

• ESP32 GitHub

ESP32 development projects are freely distributed under Espressif's MIT license on GitHub. It is established to help developers get started with ESP32 and foster innovation and the growth of general knowledge about the hardware and software surrounding ESP32 devices.

ESP32 Tools

This is a webpage where users can download ESP32 Flash Download Tools and the zip file "ESP32 Certification and Test".

• ESP-IDF

This webpage links users to the official IoT development framework for ESP32.

ESP32 Resources

This webpage provides the links to all available ESP32 documents, SDK and tools.

Revision History

| Date | Version | Release notes | | |
|--------------|---------|--|--|--|
| 2018.06 V1.4 | | Deleted Temperature Sensor in Table 2: ESP32-WROOM-32D & ESP32-WROOM-32U Specifications; Updated Chapter 3: Functional Description; Added notes to Chapter 7: Peripheral Schematics; Added Chapter 9: Recommended PCB Land Pattern; Changes to electrical characteristics: Updated Table 6: Absolute Maximum Ratings; | | |
| | | Added Table 7: Recommended Operating Conditions; Added Table 8: DC Characteristics; Updated the values of "Gain control step", "Adjacent channel transmit power" in Table 11: Transmitter Characteristics - BLE. | | |
| 2018.04 | V1.3 | Updated Figure 4 ESP32-WROOM-32U Schematics and Figure 3 ESP32-WROOM- 32D Schematics. | | |
| 2018.02 | V1.2 | Update Figure 4 ESP32-WROOM-32U Schematics. | | |
| 2018.02 | V1.1 | Updated Chapter 6 Schematics. Deleted description of low-noise amplifier. Replaced the module name ESP-WROOM-32D with ESP32-WROOM-32D. Added information about module certification in Table 2. Updated the description of eFuse bits in Section 3.1. | | |
| 2017.11 | V1.0 | First release. | | |

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<u>ESP32-WROOM-32U (16MB)</u> <u>ESP32-WROOM-32U (8MB)</u> <u>ESP32-WROOM-32D (8MB)</u> <u>ESP32-WROOM-32D</u> (16MB) ESP32-WROOM-32D ESP32-WROOM-32U